

Part Number: XGURUGX10D

10 SEGMENT BAR GRAPH ARRAY

Features

- Robust package
- Uniform light disbursement
- Ideal for backlighting logos or icons
- Excellent for flush mounting
- Standard configuration: Gray face w/ white segments
- RoHS compliant







1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted. 2. Specifications are subject to change without notice.

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Absolute Maximum Ratings (T _A =25°C)		Red (GaAsP/ GaP)	Green (GaP)	Unit	Operating Characteristics (T _A =25°C)	Red (GaAsP/GaP)	Green (GaP)	Un it	
					Forward Voltage (Typ.) (I _F =10mA)		1.9	2	V
Reverse Voltage	VR	5	5	V	Forward Voltage (Max.) (I _F =10mA)	$V_{\rm F}$	2.3	2.4	V
Forward Current	I_F	30	25	mA	Reverse Current (Max.) (V _R =5V)		10	10	uA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	160	140	mA	Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =10mA)	I_R λP	627*	565*	nm
Power Dissipation	\mathbf{P}_{D}	75	62.5	mW	Wavelength of Dominant				
Operating Temperature	$T_{\rm A}$	$-40 \sim +85$ $-40 \sim +85$		°C	Emission CIE127-2007* (Typ.)	λD	617*	568*	nm
Storage Temperature	Tstg				(I _F =10mA)				<u> </u>
Lead Solder Temperature [2mm Below Package Base]	260°C For 3~5 Seconds				Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA)		45	30	nm
A Bolativo Humidity botwoor	400/ -		1 1						_

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Part Number	r Color		Luminous Intensity CIE127-2007* (IF=10mA) ucd		Wavelength CIE127-2007* nm λΡ	Description	
			min.	typ.			
XGURUGX10D -	Red	GaAsP/GaP	3600 900*	8990 1990*	627*	10 Segments	
	Green		$5600 \\ 1400*$	11990 3990*	565*	Bar graph-Display	

Capacitance (Typ.)

 $(V_F=0V, f=1MHz)$

*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Nov 10,2018

XDSA1917 V9-X Layout: Maggie L.

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Forward Current (mA)

Forward Current (mA)



Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



re-heat temperature of 105°C or less (as measured attached to the LED pins) prior to immersion in th maximum solder bath temperature of 260°C 1. Recon therm mend pre with the with (5 sec for

not apply stress to the epoxy resin while the temperature is above 85° C. tures should not incur stress on the component when mounting and 4.Fixtur

during solidering process: success on the component when inducting SAG 205 solider aloy is recommended.
6.No more than one wave soldering pass.
7.During wave soldering, the PCB top-surface temperature should be kept below 105°C.

Remarks:

If special sorting is required (e.g. binning based on forward voltage,

luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please
- consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life. 5. The contents within this document may not be altered without prior consent by SunLED.
- 6.When any special process such as potting is required for LED assembly, please consult with SunLED representative before proceeding.
- 7. Additional technical notes are available at https://www.SunLEDusa.com/TechnicalNotes.asp